

Standard specifications of MBE β -(Al_xGa_{1-x})₂O₃ epitaxial wafers

Epitaxial layer (Growth method: MBE)

Property	Specification
Al mole fraction	$x \leq 0.23$
Dopant	Si (n-type)
Doping concentration	$\leq 1 \times 10^{18} \text{ cm}^{-3}$
Thickness	$\leq 60 \text{ nm}$

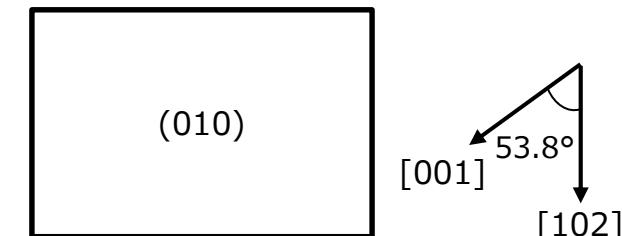
β -(Al_xGa_{1-x})₂O₃ epitaxial layer

β -Ga₂O₃ wafer

Cross section of β -Ga₂O₃
epitaxial wafer

Wafer

Property	Specification	
Dopant	Sn (n-type)	Fe (semi-insulating)
Doping concentration	$1-9 \times 10^{18} \text{ cm}^{-3}$	-
Resistivity	-	$\geq 10^{10} \Omega\text{cm}$
Orientation	(010)	
Size	10x15 mm	
Thickness	0.5 mm	
XRD FWHM	$\leq 150 \text{ arcsec}$	
Off set angle	$0^\circ \pm 1^\circ$	



Orientation



Novel Crystal Technology, Inc.

Remarks

1 These products must be used for research and development purpose only.

2 The substrates must not be used as a seed crystal.

3 The specifications are subject to change without notice.